### **General Description**

The MAX14827A integrates the high-voltage functions commonly found in industrial sensors, including drivers and regulators. The MAX14827A features two ultra low-power drivers with active reverse-polarity protection. Operation is specified for normal 24V supply voltages up to 60V. Transient protection is simplified due to high voltage tolerance allowing the use of micro TVS.

The device features a flexible control interface. Pincontrol logic inputs allow for operation with switching sensors that do not use a microcontroller. For sensors that use a microcontroller, an SPI interface is available with extensive diagnostics. For IO-Link operation, a three-wire UART interface is provided, allowing interfacing to the microcontroller UART. Finally, a multiplexed UART/SPI option allows using one serial microcontroller interface for shared SPI and UART interfaces.

The device includes on-board 3.3V and 5V linear regulators for low-noise analog/logic supply rails.

The MAX14827A is available in a (4mm x 4mm) 24-pin TQFN package and a (2.5mm x 2.5mm) 25-pin wafer-level package (WLP) and is specified over the extended -40°C to +125°C temperature range.

### **Applications**

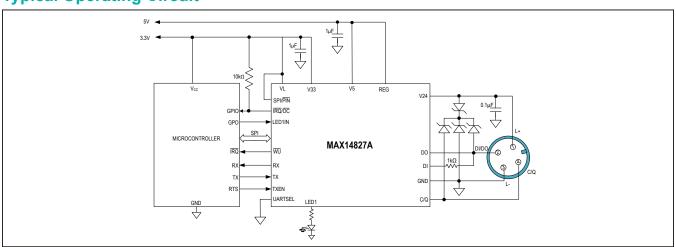
- Industrial sensors
- IO-Link sensors and actuators
- Safety applications

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

#### **Benefits and Features**

- Low Power Dissipation for Small Sensors
  - 2.3Ω/2.7Ω (typ) Driver On-Resistance
  - 70mW (typ) Power Dissipation at 100mA (When Both C/Q and DO Drivers Are Driving)
- High Configurability and Integration Reduce SKUs
  - Auxiliary 24V Digital Output and Input
  - Selectable Driver Current: 50mA to 250mA
  - SPI/Pin-Control Interface for Configuration and Monitoring
  - Multiplexed SPI/UART Interface Option
  - 5V and 3.3V Linear Regulators
  - Optional External Transistor Supports Higher Regulator Load Capability
  - Integrated LED Driver
- Selectable Driver Integrated Protection Enables
   Robust Communication
  - 65V Absolute Maximum Ratings on Interface and Supply Pins Allows for Flexible TVS Protection
  - 9V to 60V Specified Operation
  - Glitch Filters for Improved Burst Resilience and Noise
  - · Thermal Shutdown Auto-Retry Cycling
  - · Hot-Plug Supply Protection
  - Reverse Polarity Protection of All Sensor Interface
     Inputs/Outputs
  - -40°C to +125°C Operating Temperature Range

#### Ordering Information appears at end of data sheet.



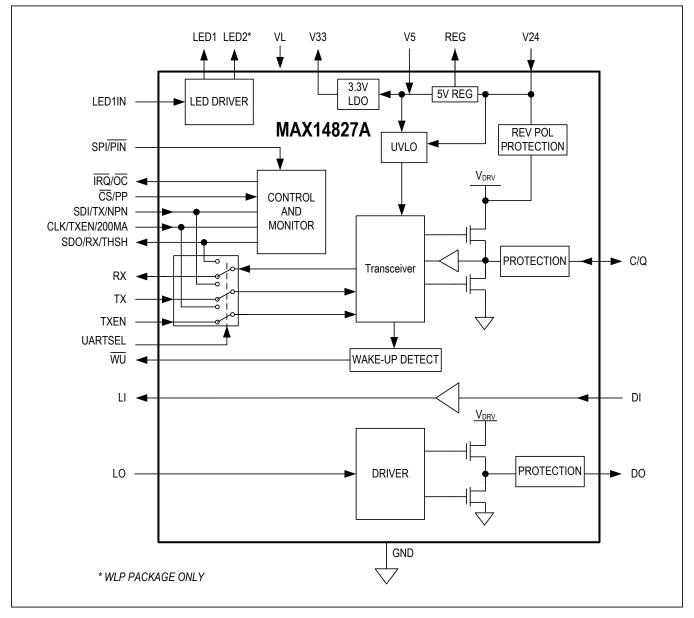
IO-Link is a registered trademark of Profibus User Organization (PNO). SPI is a trademark of Motorola, Inc.



# **Typical Operating Circuit**

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

# **Functional Diagram**



# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### **Absolute Maximum Ratings**

(All voltages referenced to GND, unless otherwise noted.)	
V2470V to +65V	
REG0.3V to (V <sub>5</sub> + 16V)	
V5, VL0.3V to +6V	
V330.3V to (V <sub>5</sub> + 0.3V)	
C/Q, DO, DI MIN: larger of -70V and (V <sub>24</sub> - 70V) to	
MAX: the lower of +70V and $(V_{24} + 70V)$	
Logic Inputs:	
CS/PP, TXEN, TX, LED1IN, LI,	
UARTSEL, CLK/TXEN/200MA, SPI/PIN,	
SDI/TX/NPN0.3V to (VI + 0.3V)	
Logic Outputs:	
RX, LI, LO $\overline{WU}$ , SDO/RX/THSH0.3V to (V <sub>L</sub> + 0.3V)	
IRQ/OC0.3V to +6V	

LED1, LED2(	0.3V to (V <sub>5</sub> +0.3V)
Continuous Current Into GND and V24	±1A
Continuous Current Into C/Q and DO	±500mA
Continuous Current Into V5 and REG	±100mA
Continuous Current Into Any Other Pin	±50mA
Continuous Power Dissipation	
TQFN (derate 27.8mW/°C above +70°C)	2222mW
WLP (derate 22.7mW/°C above +70°C)	1816mW
Operating Temperature Range	-40°C to +125°C
Maximum Junction Temperature	Internally Limited
Storage Temperature Range	-65°C to +150°C
Soldering Temperature (reflow, TQFN and WL	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **Package Information**

PACKAGE TYPE: 24 TQFN							
Package Code	T2444+4						
Outline Number	<u>21-0139</u>						
Land Pattern Number	<u>90-0022</u>						
THERMAL RESISTANCE, FOUR-LAYER BOARD							
Junction to Ambient ( $\theta_{JA}$ )	36°C/W						
Junction to Case $(\theta_{JC})$	3°C/W						

PACKAGE TYPE: 25 WLP						
Package Code	W252L2+1					
Outline Number	<u>21-0787</u>					
Land Pattern Number	Refer to Application Note 1891					
THERMAL RESISTANCE, FOUR-LAYER BOARD						
Junction to Ambient ( $\theta_{JA}$ )	44°C/W					

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### **DC Electrical Characteristics**

 $(V_{24} = 9V \text{ to } 60V, V_5 = 4.5V \text{ to } 5.5V, V_L = 2.5V \text{ to } 5.5V, V_{GND} = 0V; \text{ REG unconnected, all logic inputs at V}_L \text{ or GND}; T_A = -40^{\circ}\text{C to} +125^{\circ}\text{C}$ , unless otherwise noted. Typical values are at  $V_{24} = 24V$ ,  $V_5 = 5V$ ,  $V_L = 3.3V$ , and  $T_A = +25^{\circ}\text{C}$ , unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
V24 Supply Voltage	V <sub>24</sub>			9		60	V	
V24 Undervoltage-Lockout	V <sub>24UVLO</sub>	V <sub>24</sub> rising		6	7.8	9	v	
Threshold	▼24UVLO	V <sub>24</sub> falling		6	7.2	9	v	
V24 Undervoltage-Lockout- Threshold Hysteresis	V <sub>24UVLO_HYST</sub>				570		mV	
			C/Q and DO dis- abled (CQ_Dis = 1, DO_Dis = 1)		0.14	0.5		
V24 Supply Current	I <sub>24</sub>	V5 powered ex- ternally, REG is unconnected	C/Q and DO in push- pull configuration, CL[10] = 11, C/Q and DO high, no load on C/Q or DO		1.1	1.75	mA	
			C/Q and DO in push- pull configuration, CL[10] = 11, C/Q and DO low, no load on C/Q or DO		1.4	1.8	-	
V24 Low-Voltage Warning Threshold	V <sub>24W</sub>			14.5	16.5	18	V	
V5 Supply Voltage				4.5		5.5	V	
V5 Undervoltage-Lockout	V <sub>5UVLO</sub>	V <sub>5</sub> rising		2.8	3.5	4.5	v	
Threshold	*50VL0	V <sub>5</sub> falling		2.8	3.45	4.5	v	
			C/Q and DO dis- abled (CQ_Dis = 1, DO_Dis = 1), V33 disabled (V33_Dis = 1)		0.64	0.9		
V5 Supply Current	ent I <sub>5_IN</sub> to V5, nected	External 5V applied to V5, REG is uncon- nected, no load on LED1 or LED2	to V5, REG is uncon nected, no load on	C/Q and DO in push- pull configuration, CL[10] = 11, C/Q and DO high, V33 enabled, no load on C/Q, DO, or V33		1.37	1.75	mA
			C/Q and DO in push- pull configuration, CL[10] = 11, C/Q and DO low, V33 enabled, no load on C/Q, DO, or V33		1.41	1.8		
V <sub>L</sub> Logic-Level Supply Voltage	VL			2.5		5.5	V	
V <sub>L</sub> Undervoltage Threshold	V <sub>LUVLO</sub>			0.9	1.7	2.4	V	
V <sub>L</sub> Logic-Level Supply Current	١L	All logic inputs at V <sub>L</sub> outputs unconnecte			0.25	3	μA	

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### **DC Electrical Characteristics (continued)**

(V<sub>24</sub> = 9V to 60V, V<sub>5</sub> = 4.5V to 5.5V, V<sub>L</sub> = 2.5V to 5.5V, V<sub>GND</sub> = 0V; REG unconnected, all logic inputs at V<sub>L</sub> or GND; T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>24</sub> = 24V, V<sub>5</sub> = 5V, V<sub>L</sub> = 3.3V, and T<sub>A</sub> = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS	
5V LINEAR REGULATOR/CO						1			
V5 Output Voltage	V <sub>5</sub>	REG = V5, no load o	4.75	5.00	5.25	V			
Load Regulation	ΔV <sub>5 LDR</sub>	REG = V5, 0mA < I <sub>LO</sub>	AD <	30mA, V <sub>24</sub> = 24V		0.02	0.2	%	
Line Regulation	ΔV <sub>5 LNR</sub>	REG = V5, I <sub>LOAD</sub> = 1r	mA, \	/ <sub>24</sub> from 9V to 60V		0.01	4	mV/V	
REG Output Current	I <sub>REG</sub>	Internal regulator or	exte	rnal NPN			30	mA	
V24 REG Dropout Voltage	ΔV <sub>REG</sub>	V <sub>24</sub> = 9V, V <sub>5</sub> = 4.5V,	IRE	<sub>G</sub> = 5mA		2.35		V	
REG Open Voltage	V <sub>REG</sub> OPN	V <sub>24</sub> = 60V, V <sub>5</sub> = 4.5	V, no	load on REG	10	13	16	V	
V5 Capacitance	CV <sub>5</sub>	Allowed capacitance nected to V5 (Note 2		V5, REG con-	0.8	1	2	μF	
3.3V LINEAR REGULATOR (\	/33)								
V33 Output Voltage	V <sub>33</sub>	No load on V33			3.1	3.3	3.5	V	
V33 Load Regulation	V <sub>33_LDR</sub>	0mA < I <sub>LOAD</sub> < 30m	A		0	0.4	0.8	%	
V33 Capacitance	CV <sub>33</sub>	Allowed capacitance abled (Note 2)	e on ۱	V33, V33 en-	0.8	1		μF	
C/Q, DO DRIVER		· · · ·							
Driver Or Desistence	R <sub>OH</sub>		High-side enabled, V <sub>24</sub> = 24V, CL[10] = 11, I <sub>LOAD</sub> = -200mA (Note 2)			2.65	4.6		
Driver On-Resistance	R <sub>OL</sub>	Low-side enabled, V <sub>24</sub> = 24V, CL[10] = 11, I <sub>LOAD</sub> = +200mA (Note 2)			2.3 4.45		Ω		
	Limit I <sub>CL</sub>	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$		r î	50	65	80	 mA	
				CL[10] = 01	100	120	150		
				CL[10] = 10	200	230	275		
Driver Current Limit				CL[10] = 11	250	290	350		
					100	120	150		
				CLK/TXEN/ 200MA = high	200	230	275	1	
Driver Peak Current	I <sub>CL PEAK</sub>	DC current					490	mA	
		C/Q driver is disable disabled (Rx_Dis = 1 $65V$ ) $\leq V_{C/Q} \leq +60V$	1), V		-70		+10		
			high	N mode, set to n impedance (TX w), V <sub>C/Q</sub> = 24V		17.4		-	
C/Q Leakage Current	ILEAK_CQ		high	P mode, set to n impedance (TX igh) V <sub>C/Q</sub> = 0V		0		μΑ	
		C/Q driver enabled	higł	P mode, set to n impedance (TX ) V <sub>C/Q</sub> = 24V		22.9			
			high	P mode, set to n impedance (TX ) V <sub>C/Q</sub> = 0V		-43.5			

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### **DC Electrical Characteristics (continued)**

(V<sub>24</sub> = 9V to 60V, V<sub>5</sub> = 4.5V to 5.5V, V<sub>L</sub> = 2.5V to 5.5V, V<sub>GND</sub> = 0V; REG unconnected, all logic inputs at V<sub>L</sub> or GND; T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>24</sub> = 24V, V<sub>5</sub> = 5V, V<sub>L</sub> = 3.3V, and T<sub>A</sub> = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL		TIONS	MIN	TYP	MAX	UNITS
		DO driver is disabled 24V, (V <sub>24</sub> -65V) $\leq$ V <sub>D</sub>		-10		+10	
		<u>240, (024 -030) 2 0</u>	NPN mode, set to high impedance (LO = low) , V <sub>DO</sub> = 24V PNP mode, set to high impedance (LO		6.0 0		-
DO Leakage Current	I <sub>LEAK_DO</sub>	DO driver enabled	= high) $V_{DO} = 0V$ PNP mode, set to high impedance (CQ- DO <sub>PAR</sub> = 1, TXEN = 0), $V_{DO} = 24V$		11.6		μΑ
			PNP mode, set to high impedance (CQ- $DO_{PAR} = 1, TXEN =$ 0), $V_{DO} = 0V$		-42.4		
C/Q Output Reverse Current	I <sub>REV_CQ</sub>	C/Q driver enabled a figuration, $V_{24} = 30V$ or ( $V_{GND} - 5V$ )		-60		+1000	μA
DO Output Reverse Current	I <sub>REV_DO</sub>	DO driver enabled at figuration, $V_{24} = 30V$ or ( $V_{GND} - 5V$ )		-60		+1000	μA
West Dulldaum Ourset	er	SPI/PIN = high, driv- er disabled (CQ_Dis		200	300	400	
Weak Pulldown Current		= 1, DO_Dis =1)	V <sub>DRIVER</sub> = 24V, CQ_WPD = 1, DO_WPD = 1, CQ_WPU = 0, DO_WPU = 0	200	470	1000	- μΑ
Weak Pullup Current	I <sub>PU</sub>	$\begin{array}{l} SPI/\overline{PIN} = high, driver\\ disabled (CQ_Dis = 1,\\ DO_Dis = 1),\\ V_{DRIVER} = V_{24} - 5V \end{array}$	CQ_WPU = 1, DO_WPU = 1, CQ_WPD = 0, DO_WPD = 0,	-400	-300	-200	μΑ
C/Q, DI RECEIVER							,
Input Voltage Range	V <sub>IN</sub>	For valid RX/LI logic	T	V <sub>24</sub> – 65		+65	V
C/Q, DI Input Threshold High	V <sub>TH</sub>	C/Q driver disabled	V <sub>24</sub> > 18V V <sub>24</sub> < 18V	11 59	11.8 65.5	12.5 72	V % of V <sub>24</sub>
C/Q, DI Input Threshold Low	V <sub>TL</sub>	C/Q driver disabled	V <sub>24</sub> > 18V V <sub>24</sub> < 18V	9 45	9.8 54.5	10.5 63	V % of V <sub>24</sub>
C/Q, DI Input Hysteresis	V <sub>HYS_CQ</sub>	C/Q driver disabled	$V_{04} > 18V$		2 11		V % of V <sub>24</sub>
C/Q Input Capacitance	C <sub>IN_CQ</sub>	Driver disabled, wea down disabled, f = 10	k pull-up and pull-		50		pF

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### **DC Electrical Characteristics (continued)**

 $(V_{24} = 9V \text{ to } 60V, V_5 = 4.5V \text{ to } 5.5V, V_L = 2.5V \text{ to } 5.5V, V_{GND} = 0V; REG unconnected, all logic inputs at V_L or GND; T_A = -40°C \text{ to } +125°C, unless otherwise noted. Typical values are at V_{24} = 24V, V_5 = 5V, V_L = 3.3V, and T_A = +25°C, unless otherwise noted.) (Note 1)$ 

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DI Input Capacitance	C <sub>IN DI</sub>	f = 100kHz			10		pF
C/Q Input Current		C/Q driver disabled (CQ_Dis = 1), C/Q	$-5V \le V_{C/Q} \le (V_{24} + 5V)$	-10		+30	
C/Q input Current	IIN_CQ	receiver enabled, V <sub>24</sub> = 24V	(V <sub>24</sub> - 65V)≤ V <sub>C/Q</sub> ≤ +60V	-70		+70	μA
DI Leakage Current	ILEAK_DI	DI receiver disabled 24V, $(V_{24} - 65V) \le V$		-40		+150	μA
DI Input Current	I <sub>IN_DI</sub>	DI receiver enabled,		-10		+35	μA
		V <sub>24</sub> = 24V	(V <sub>24</sub> - 65V) ≤ V <sub>DI</sub> ≤ +60V	-40		+200	μπ
LOGIC INPUTS (CS/PP, TXEN	, TX, LO, LED1IN	, CLK/TXEN/200MA,	SPI/PIN, SDI/TX/NPN	1)			
Logic Input Voltage Low	VIL					$0.2 \times V_L$	V
Logic Input Voltage High	V <sub>IH</sub>			0.8 x V <sub>L</sub>			V
Logic Input Leakage Current	I <sub>LEAK</sub>	Logic input = GND c	or VL	-1		+1	μA
LOGIC OUTPUTS (RX, LI, WU	, IRQ/OC, SDO/R	X/THSH)					
Logic Output Voltage Low	V <sub>OL</sub>	I <sub>OUT</sub> = -5mA		·		0.4	V
Logic Output Voltage High	V <sub>OH</sub>	I <sub>OUT</sub> = 5mA		V <sub>L</sub> - 0.4			V
IRQ/OC Open-Drain Leakage Current	I <sub>LK_OD</sub>	IRQ/OC high impeda IRQ/OC = GND or V		-1		+1	μA
SDO Leakage Current	I <sub>LK_SDO</sub>	SPI/ $\overline{PIN}$ = high, $\overline{CS}$ / THSH = GND or VL	PP = high, SDO/RX/	-1		+1	μA
RX, LI Leakage Current	I <sub>LK_RXLI</sub>	SPI/ <del>PIN</del> = high, DI_I RX_Dis = 1, RX/LI =		-1		+1	μA
LED DRIVERS (LED1, LED2)							
LED Output Voltage Low	V <sub>LEDOL</sub>	I <sub>OUT</sub> = -5mA				0.4	V
LED Output Voltage High	VLEDOH	I <sub>OUT</sub> = 10mA		V5-0.4			V
THERMAL MANAGEMENT	-						
Thermal Warning Threshold	T <sub>WRN</sub>	Die junction tempera TempW and TempW			+140		°C
Thermal Warning Threshold Hysteresis	T <sub>WRN_HYS</sub>	Die junction tempera TempW bit cleared	ature falling,		15		°C
Per-Driver Thermal Shutdown Temperature	T <sub>SHUT_D</sub>	Driver temperature rising, temperature at which the driver is turned off			+160		°C
Per-Driver Thermal Shutdown Temperature Hysteresis	T <sub>SHUT_DHYS</sub>	Driver temperature falling			15		°C
IC Thermal Shutdown	T <sub>SHUT_IC</sub>	Die temperature risi ThuShutInt bits are s		+170		°C	
IC Thermal-Shutdown Hys- teresis	T <sub>SHUT_ICHYS</sub>	Die temperature falli cleared	ng, ThShut bit is		15		°C

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### **AC Electrical Characteristics**

(V<sub>24</sub> = 18V to 30V, V<sub>5</sub> = 4.5V to 5.5V, V<sub>L</sub> = 2.5V to 5.5V, V<sub>GND</sub> = 0V; REG unconnected, all logic inputs at V<sub>L</sub> or GND; T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>24</sub> = 24V, V<sub>5</sub> = 5V, V<sub>L</sub> = 3.3V, and T<sub>A</sub> = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDI	MIN	TYP	MAX	UNITS	
C/Q, DO DRIVER							
Driver Low-to-High Propagation	Driver Low-to-High Propagation Push-pull and PNP configu				0.16	0.4	
Delay	<sup>t</sup> PDLH_PP	NPN configuration, Fig	jure 1		0.16		μs
Driver High-to-Low Propagation		Push-pull and NPN co	nfiguration, Figure1		0.28	0.4	
Delay	<sup>t</sup> PDHL_PP	PNP configuration, Fig	ure 1		0.28		μs
Driver Skew	tSKEW	Push-pull configuration,   <sup>t</sup> PDLH <sup>- t</sup> PDHL	Figure 1	-0.3		+0.3	μs
Driver Rise Time	t <sub>RISE</sub>	Push-pull and PNP cor	nfiguration, Figure 1		0.12	0.4	μs
Driver Fall Time	t <sub>FALL</sub>	Push-pull and NPN co	nfiguration, Figure 1		0.12	0.4	μs
Driver Enable Time High	t <sub>ENH</sub>	Push-pull and PNP co DOPar = 1 for DO, Fig	-		0.15	0.4	μs
Driver Enable Time Low	t <sub>ENL</sub>	Push-pull and NPN co DOPar = 1 for DO, Fig	•		0.27	0.4	μs
Driver Disable Time High	<sup>t</sup> DISH	Push-pull and PNP co DOPar = 1 for DO, Fig	•		1.8	3	μs
Driver Disable Time Low	t <sub>DISL</sub>	Push-pull and NPN co DOPar = 1 for DO, Fig			1.5	3	μs
C/Q, DI RECEIVER (Figure 4)							
C/Q Receiver Low-to-High	t	SPI/PIN = high or low,		0.85	1.3	2.1	μs
Propagation Delay	<sup>t</sup> PRLH_CQ	SPI/PIN = high, CQFil		0.2	0.3	0.5	μο
C/Q Receiver High-to-Low	t <sub>PRHL_CQ</sub>	$SPI/\overline{PIN}$ = high or low,		0.85	1.3	2.1	μs
Propagation Delay		SPI/PIN = high, CQFil	= 1	0.2	0.3	0.5	
DI Receiver Low-to-High Propa- gation Delay	<sup>t</sup> PRLH_DI			1.3	2.2	3.5	μs
DI Receiver High-to-Low Propa- gation Delay	<sup>t</sup> PRHL_DI			1.3	2.2	3.5	μs
DRIVER CURRENT LIMITING		1	1				
			CL_BL[10] = 00		0.128		
		SPI/PIN = high	CL_BL[10] = 01		0.5		
Blanking Time	t <sub>CL_ARBL</sub>		CL_BL[10] = 10	1 5			ms
			CL_BL[10] = 11				
		SPI/PIN = low			0.128		
			TAr[10] = 00		50		
Autorate / Dariad	ta	SPI/ $\overline{PIN}$ = high, $TAr[10] = 01$		100		]	
Autoretry Period			ArEn = 1 (Note 3) TAr[10] = 10		200		ms
		TAr[10] = 11			500		

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### **AC Electrical Characteristics (continued)**

 $(V_{24} = 18V \text{ to } 30V, V_5 = 4.5V \text{ to } 5.5V, V_L = 2.5V \text{ to } 5.5V, V_{GND} = 0V; \text{ REG unconnected, all logic inputs at V}_L \text{ or GND}; T_A = -40^{\circ}\text{C to} +125^{\circ}\text{C}$ , unless otherwise noted. Typical values are at  $V_{24} = 24V$ ,  $V_5 = 5V$ ,  $V_L = 3.3V$ , and  $T_A = +25^{\circ}\text{C}$ , unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
WAKE-UP DETECTION (Figure 5	5)					
Wake-Up Input Minimum Pulse Width	twumin	C <sub>L</sub> = 3nF	55	66	75	μs
Wake-Up Input Maximum Pulse Width	twumax		85	95	110	μs
WU Output Low Time	twul	Valid wake-up condition on C/Q	100	200	300	MS
SPI TIMING (CS/PP, CLK/TXEN/2	200MA,SDI,T	X/NPN, SDO/RX/THSH) (Figure 6)				
Maximum SPI Clock Frequency			12.5			MHz
CLK/TXEN/200MA Clock Period	t <sub>CH+CL</sub>		80			ns
CLK/TXEN/200MA Pulse-Width High	t <sub>CH</sub>		40			ns
CLK/TXEN/200MA Pulse-Width Low	t <sub>CL</sub>		40			ns
CS/PP Fall to CLK/TXEN/200MA Rise Time	tcss		20			ns
CLK/TXEN/200MA Rise to CS/ PP Rise Hold Time	t <sub>CSH</sub>		40			ns
SDI/TX/NPN Hold Time	t <sub>DH</sub>		10			ns
SDI/TX/NPN Setup Time	t <sub>DS</sub>				25	ns
Output Data Propagation Delay	t <sub>DO</sub>				20	ns
SDO/RX/THSH Rise and Fall Times	t <sub>FT</sub>				20	ns
Minimum CS/PP Pulse	t <sub>CSW</sub>				10	ns

Note 1: All devices are 100% production tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range are guaranteed by design.

Note 2: Not production tested. Guaranteed by design.

Note 3: Autoretry functionality is not available in pin-mode.

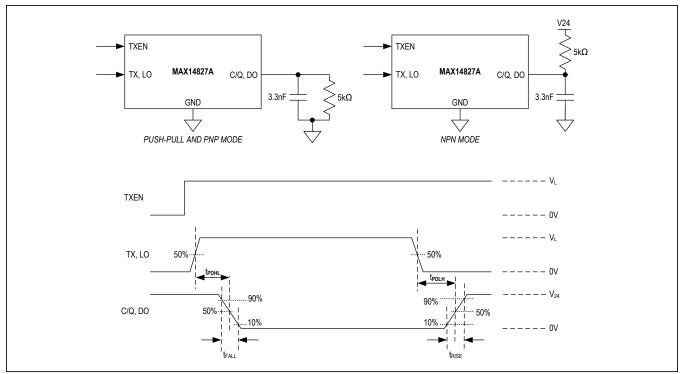


Figure 1. C/Q and LO Driver Propagation Delays and Rise/Fall Times

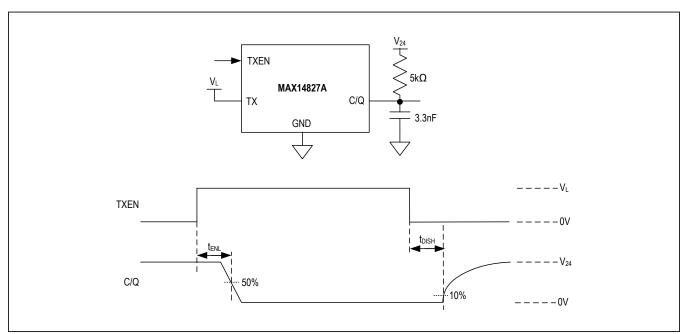


Figure 2. C/Q Driver Enable Low and Disable High Timing with External Pullup Resistor

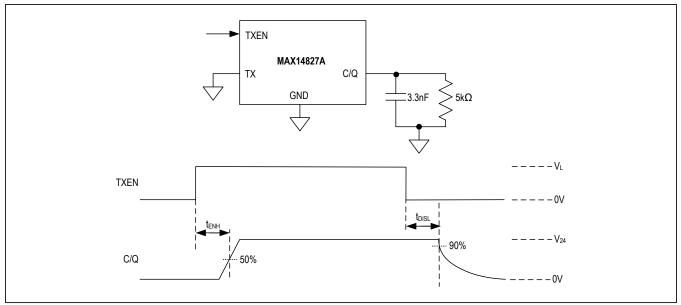


Figure 3. C/Q Driver Enable High and Disable Low Timing

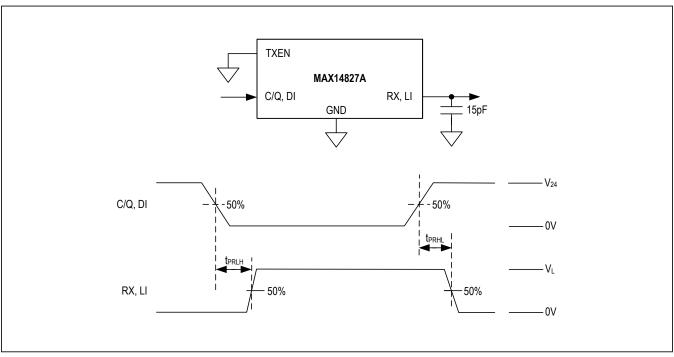


Figure 4. C/Q and DI Receiver Propagation Delays

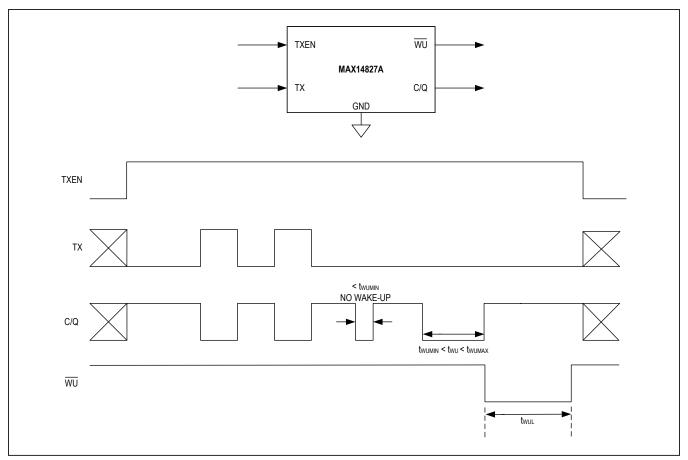


Figure 5. Wake-Up Detection Timing

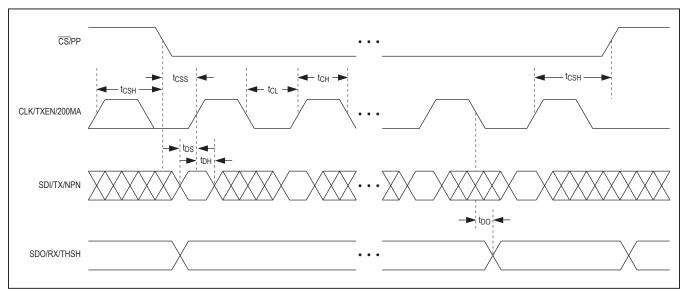
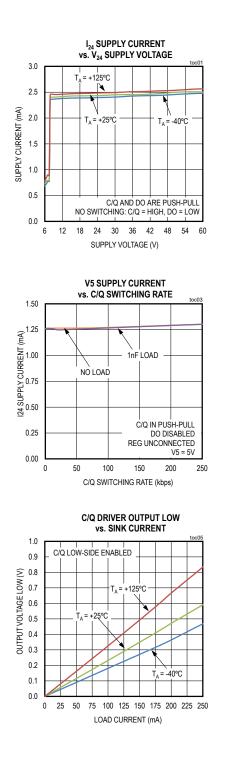


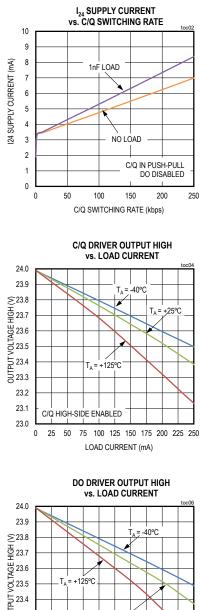
Figure 6. SPI Timing Diagram

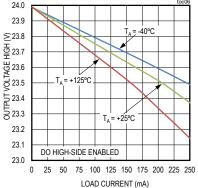
# Low-Power, Ultra-Small, Dual Driver, **IO-Link Device Transceiver**

# **Typical Operating Characteristics**

 $(V_{24} = 24V, V_L = V_{33}, REG$  is shorted to V5, C/Q and DO in push-pull configuration,  $T_A = +25^{\circ}C$ , unless otherwise noted.)



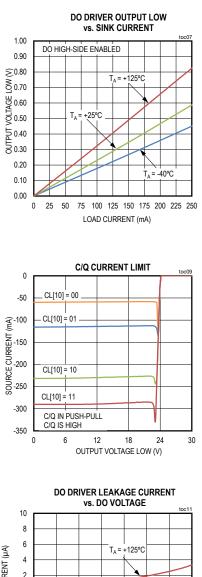


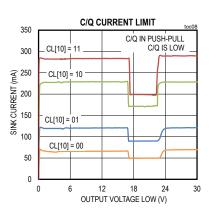


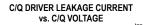
# Low-Power, Ultra-Small, Dual Driver, **IO-Link Device Transceiver**

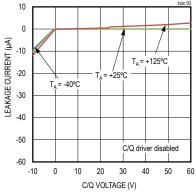
### **Typical Operating Characteristics (continued)**

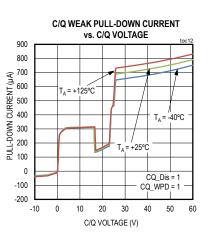
(V<sub>24</sub> = 24V, V<sub>L</sub> = V<sub>33</sub>, REG is shorted to V5, C/Q and DO in push-pull configuration, T<sub>A</sub> = +25°C, unless otherwise noted.)











LEAKAGE CURRENT (µA) 2 0 -2 = -40°C and +25°C -4 -6 -8 DO driver disabled -10

DO VOLTAGE (V)

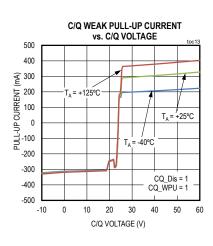
60

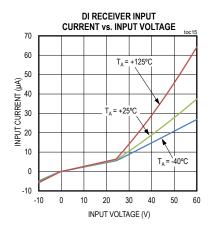
-10 0 10 20 30 40 50

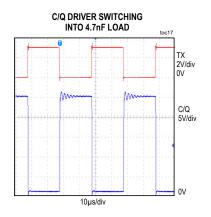
# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

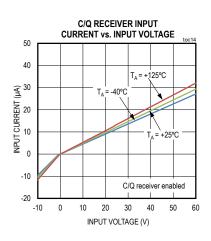
### **Typical Operating Characteristics (continued)**

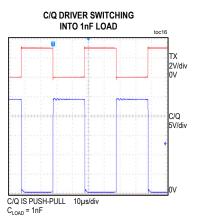
 $(V_{24} = 24V, V_L = V_{33}, REG is shorted to V5, C/Q and DO in push-pull configuration, T_A = +25°C, unless otherwise noted.)$ 

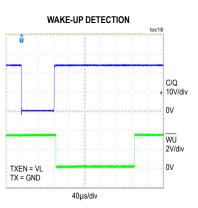








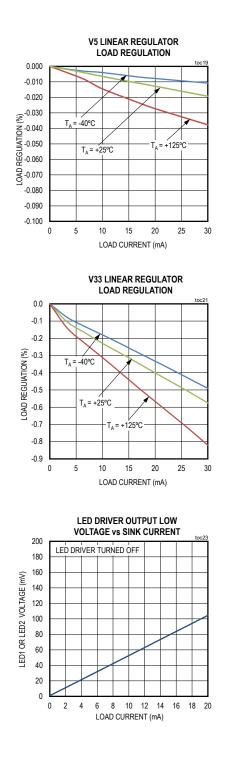


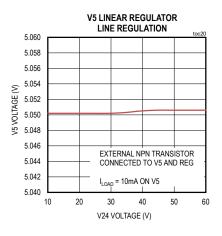


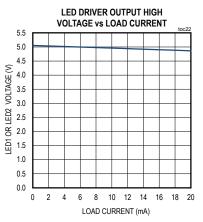
# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

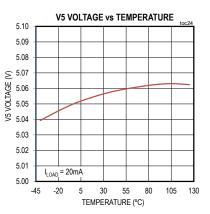
### **Typical Operating Characteristics**

( $V_{24}$  = 24V,  $V_L$  =  $V_{33}$ , REG is shorted to V5, C/Q and DO in push-pull configuration,  $T_A$  = +25°C, unless otherwise noted.)



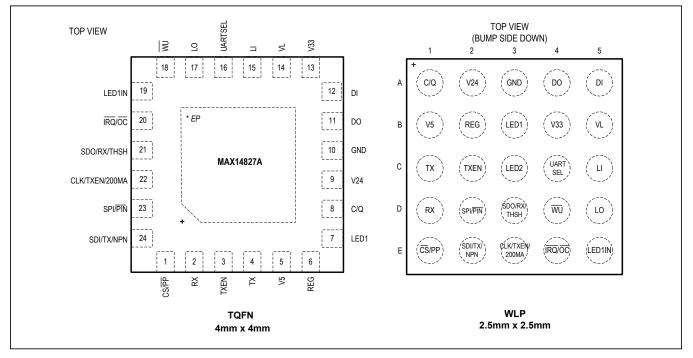






# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

# **Pin Configuration**



### **Pin Description**

PI	N				FUNCTION	
TQFN	WLP	NAME	PIN DESCRIP- TION	PARALLEL MODE (SPI/PIN = High)	MULTIPLEXED MODE (SPI/PIN = High)	PIN MODE (SPI/PIN = Low)
				UARTSEL = Low	UARTSEL = high	
1	E1	CS/PP	CS/PP Logic Input	SPI active-low chip- select input. Drive $\overline{CS}/PP$ low to start the SPI read/write cycle. Drive $\overline{CS}/PP$ high to end the SPI cycle. UART inter- face is enabled on RX, TX, and TXEN.	SPI chip-select and UART signal select input. When $\overline{CS}/PP$ is high, the SPI interface is disabled and UART interface mode is en- abled on the SDO/RX/ THSH, SDI/TX/NPN, and CLK/TXEN/200MA logic pins.	Push-pull select input. Drive $\overline{CS}$ /PP high to en- able push-pull mode for the C/Q and DO drivers. Drive $\overline{CS}$ /PP low to select PNP or NPN operation for the drivers.
2	D1	RX	C/Q Receiver Logic Output	RX is the inverse logic abled with the SPI inte ance when Rx_Dis = 1	RX is the inverse logic of C/Q. RX is always active.	

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

PI	N			FUNCTION				
TQFN	WLP	NAME	PIN DESCRIP- TION	PARALLEL MODE (SPI/PIN = High)	MULTIPLEXED MODE (SPI/PIN = High)	PIN MODE (SPI/PIN = Low)		
				UARTSEL = Low	UARTSEL = high	(SFI/FIN - LOW)		
3	C2	TXEN	C/Q Driver En- able Logic Input	Drive TXEN high to enable the C/Q driver. See Table 1.	With $\overline{CS}/PP$ low and ENMPX = 0, drive TXEN high to enable C/Q.	Drive TXEN high to en- able the C/Q driver. Drive TXEN low to disable the C/Q driver and enable the C/Q receiver.		
4	C1	тх	C/Q Driver Com- munication Input	The logic on the C/Q output is the inverse logic level of the sig- nal on the TX input. See Table 1.	With $\overline{CS}/PP$ low and ENMPX = 0, the logic on the C/Q output is the inverse logic level of the signal on the SDI/TX/ NPN input. Signals on TX are ignored. See the Mode Selection table.	The logic on the C/Q output is the inverse logic level of the signal on the TX input when TXEN is high.		
5	B1	V5	5V Power-Sup- ply Input/Output	1μF capacitor. V5 can external regulator. Το ι		5V linear regulator or by an		
6	B2	REG	5V Regulator Control Output	base of an external NF	ear regulator, connect REG t PN pass transistor. Leave RE 5V supply to bypass the inte			
7	В3	LED1	LED Driver Output 1	LED1 is a 5V logic out limiting resistor in serie the LED to limit the LE controlled by driving th of through the SPI inte high to turn on the LEI turn off the LED. Alterr input high to turn on th to turn off the LED. Se	LED1 is a 5V logic output. Connect a current-limiting resistor in series between LED1 and the LED to limit the LED current. Drive the LED1IN input high to turn on the LED, drive LED1IN low to turn off the LED.			
	C3	LED2	LED Driver Output 2	LED2 is a 5V logic output. Connect a current- limiting resistor in series between LED2 and the LED to limit the LED current. Set the LED2b bit high to turn on the LED, clear the LED2b bit to turn off the LED.				

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

PI	N				FUNCTION		
TQFN	WLP	NAME	PIN DESCRIP- TION	PARALLEL MODE (SPI/PIN = High)	MULTIPLEXED MODE (SPI/PIN = High)	PIN MODE (SPI/PIN = Low)	
			UARTSEL = Low UARTSEL = high		UARTSEL = high		
8	A1	C/Q	C/Q Transceiver Output/ Input	The C/Q driver can be with the logic input/out SPI interface. Drive TX C/Q driver. The logic o inverse logic-level of th RX is the logic inverse	Drive TXEN high to en- able the C/Q driver. The logic on the C/Q output is the inverse logic-level of the signal in the TX input. RX is the logic inverse of C/Q. Configure the C/Q driver with the pin-mode inputs.		
9	A2	V24	Power-Supply Input	Bypass V24 to GND w possible.	ith a 0.1μF ceramic capacito	or as close to the device as	
10	A3	GND	Ground				
11	A4	DO	DO Driver Output	DO is the inverse logic DO driver can be enab controlled, and monitor output pins or through	DO is the inverse logic level of the LO input. Configure the DO driver with the pin-mode inputs. DO cannot be disabled in pin-mode.		
12	A5	DI	DI Receiver Input	or through the SPI inter inverse logic-level of the	The DI receiver can be monitored on the LI output I or through the SPI interface. The LI output is the inverse logic-level of the signal on the DI input. Connect a $1k\Omega$ resistor in series with the DI pin.		
13	В4	V33	3.3V Linear Reg- ulator Output	Bypass V33 to GND wi close to the IC as poss be disabled through the	ble. The V33 regulator can	Bypass V33 to GND with a 1µF capacitor as close to the IC as possible. V33 cannot be disabled in pin- mode.	
14	B5	VL	Logic-Level Supply Input		vels on all of the logic inputs ′L. Bypass VL to GND with a	and outputs. Apply a voltage a 0.1µF ceramic capacitor.	
15	C5	LI	DI Receiver Logic Output	The LI output is the inv nal on the DI input. Dis the SPI interface. LI is DI_Dis bit is set.	The LI output is the inverse logic-level of the signal on the DI input. LI cannot be disabled in pin-mode.		
16	C4	UARTSEL	UART Interface Select Logic Input	Drive UARTSEL low to use RX, TX, and TXEN for UART signaling.		UARTSEL is inactive when SPI/PIN is low.	

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

PI	N				FUNCTION	
TQFN	WLP	NAME	PIN DESCRIP- TION	PARALLEL MODE (SPI/PIN = High)	MULTIPLEXED MODE (SPI/PIN = High)	PIN MODE (SPI/PIN = Low)
				UARTSEL = Low	UARTSEL = high	
17	D5	LO	DO Driver Logic Input	The logic on the DO or level of the signal on th control, and monitor th logic pins or through th	The logic on the DO output is the inverse logic- level of the signal on the LO input. Configure the DO driver with the pin- mode inputs.	
18	D4	WU	Wake-Up Re- quest Push-Pull Output	WU asserts low for 200 tected on the C/Q line.	vake-up condition is de-	
19	E5	LED1IN	LED1 Driver Logic Input	LED1 driver. The LED	ow to enable/disable the I driver can also be con- interface. See Table 2.	Drive LED1IN high to turn on the LED connected to LED1. Drive LED1IN low to turn the LED driver off.
20	E4	ĪRQ/OC	Open-Drain Interrupt/ Over-current Output	IRQ/OC asserts when RUPT register is set. ĪI the INTERRUPT regis	RQ/OC deasserts when	$\overline{\text{IRQ/OC}}$ asserts low when the load current on the C/Q or DO output exceeds the set current limit.
21	D3	SDO/ RX/ THSH	SPI Serial Data Output/ RX Logic Out- put/ Thermal Shut- down Indicator	SPI serial data output	When CS/PP is high, the SPI interface is dis- abled and UART inter- face mode is enabled. SDO/RX/THSH is the logic inverse of C/Q.	SDO/RX/THSH asserts low when the IC enters thermal shutdown. SDO/ RX/THSH deasserts when the device returns to normal operation.

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

PI	N				FUNCTION		
TQFN	WLP	NAME	PIN DESCRIP- TION	PARALLEL MODE (SPI/PIN = High)	MULTIPLEXED MODE (SPI/PIN = High)		
				UARTSEL = Low	UARTSEL = high	(SPI/PIN = Low) Drive CLK/TXEN/200MA high to enable a 200mA current limit on the C/Q and DO driver outputs. Drive CLK/TXEN/200MA low to set the current limit for the driver outputs to 100mA. Tation. Drive SPI/PIN low for Drive SDI/TX/NPN high to set the C/Q and DO driver outputs in NPN mode. Drive SDI/TX/NPN low to set the driver outputs in PNP mode. SDI/TX/NPN is ignored when the CS/	
22	E3	CLK/ TXEN/ 200MA	SPI Clock Input/ UART TXEN Input/ Current Limit Setting Input	SPI clock input SPI clock inpu		high to enable a 200mA current limit on the C/Q and DO driver outputs. Drive CLK/TXEN/200MA low to set the current limit for the driver outputs to	
23	D2	SPI/PIN	SPI or Pin-Mode Select Input	Drive SPI/PIN high for SPI or UART interface operation. Drive SPI/PIN low for pin-mode operation.			
24	E2	SDI/TX/ NPN	SPI Serial Data Input/ TX Logic Input/ NPN Driver Mode Select Input	SPI serial data input	When CS/PP is high, the SPI interface is dis- abled and UART inter- face mode is enabled. Drive SDI/TX/NPN to switch C/Q. C/Q is the logic inverse of the SDI/TX/NPN input.	set the C/Q and DO driver outputs in NPN mode. Drive SDI/TX/NPN low to set the driver outputs in PNP mode. SDI/TX/NPN	
EP	-	EP	Exposed pad. Cor	nect to ground. Not inter	nded as the main ground co	nnection.	

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### Table 1. C/Q and DO Control

SPI/PIN TXEN		TX OR LO											CQ_DIS OR DO_DIS	CQ_Q OR DO_Q	NPN	MODE	PNP MODE		PP MODE	
					C/Q	DO	C/Q	DO	C/Q	DO										
		L	-	-	Z	Z	Z	Н	Z	Н										
	L	н	-	-	Z	L	Z	Z	Z	L										
L	Н	L	-	-	Z	Z	Н	Н	Н	Н										
	п	н	-	-	L	L	Z	Z	L	L										
		L	0	0	Z	Z	Z	Н	Z	Н										
		L	0	1	Z	Z	Н	Н	Н	Н										
	L	н	0	0	Z	L	Z	Z	Z	L										
		н	0	1	Z	Z	Н	Н	Н	Н										
н		L	0	0	Z	Z	Н	Н	Н	Н										
		L	0	1	Z	Z	Н	Н	Н	Н										
	Н	н	0	0	L	L	Z	Z	L	L										
		н	0	1	Z	Z	Н	Н	Н	Н										
	Х	Х	1	Х	Z	Z	Z	Z	Z	Z										

X = Don't care, Z = High impedance

### Table 2: LED1 Configuration

LED1IN	LED1B BIT	LED1 DRIVER STATUS
	0	OFF
L	1	ON
ц	0	ON
	1	ON

# Table 3. Driver NPN, PNP, PP Selection inPin-Mode

SPI/PIN	CS/PP	SDI/TX/NPN	C/Q AND DO DRIV- ER MODE
L	L	L	PNP
L	L	Н	NPN
L	Н	L	PUSH-PULL
L	Н	Н	PUSH-PULL
н	х	х	C/Q and DO Modes are set with the SPI interface

### **Detailed Description**

The MAX14827A is an industrial sensor output driver/ IO-Link device transceiver. The IC integrates the high voltage functions commonly found in sensors, including two 24V line driver and two on-board linear regulators (LDOs). The MAX14827A can be configured and monitored either through the SPI interface or by setting logic interface pins.

The MAX14827A features multiple programmable functions that allow the user to optimize operation and power dissipation for various loads and application scenarios.

The integrated 3.3V and 5V LDOs provide the power needed for low noise analog and logic supply rails.

#### SPI, UART, or Pin-Mode Interface

#### Pin-Mode

The MAX14827A provides a selectable SPI or pin interface to configure and monitor device operation. Drive the SPI/PIN input high to use the SPI. Drive SPI/PIN low to use the pin interface (pin-mode control).

When operating in pin mode, the following functionality is set and cannot be changed:

- RX and DI are enabled (cannot be disabled)
- RX deglitch filter is enabled
- Weak pull-ups/pull-downs on C/Q and DO are disabled
- · Autoretry functionality is disabled
- The blanking time on C/Q and DO is 128µs

#### SPI Operation (Parallel Operating Mode)

When the MAX14827A is operated in SPI mode, an external UART can be connected to separate UART interface pins (TX, RX, TXEN). This is called the parallel SPI/UART operating mode. This is the common approach used when the microcontroller offers a UART and a separate SPI port in the <u>Typical Operating Circuit</u>. Drive UARTSEL low for operation in parallel mode.

#### SPI Operation (Multiplexed Mode)

In cases where only one microcontroller serial port is available with both SPI and UART functions, the MAX14827A can be operated in multiplexed SPI/UART mode. This is feasible in IO-Link operation due to the defined idle times in the IO-Link cycle time. In multiplexed mode, the UART and SPI pins are shared. Two operating modes are available in multiplexed mode, as selected by the ENMPX bit.

When ENMPX = 0, UART and SPI operation are selected by setting the  $\overline{CS}$ /PP input. In this mode the SPI interface is active when  $\overline{CS}$ /PP is low and UART operation when  $\overline{CS}$ /PP is high.

IO-Link is a registered trademark of Profibus User Organization (PNO). SPI is a trademark of Motorola, Inc.

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

When ENMPX = 1, UART and SPI operations are selected by setting the UARTSEL input. To avoid glitches on C/Q, CLK/TXEN/200MA and SDI/TX/NPN are sampled on the falling edge of UARTSEL in this mode. See <u>Mode</u> Selection Table for more information.

When entering multiplexed mode, set TXEN low and TX high to disable the driver.

IRQ/OC is active in both multiplexed modes during UART communication.

#### 24V Interface

The MAX14827A features an IO-Link transceiver interface capable of operating with voltages up to 60V. This is the 24V interface and includes the C/Q input/output, the logic-level digital output (DO), the logic-level digital input (DI), and the V24 supply.

The MAX14827A features selectable push-pull, high-side (PNP), or low-side (NPN) switching drivers at C/Q and DO.

#### **Configurable Drivers (Pin-Mode)**

In pin-mode, use SDI/TX/NPN and  $\overline{CS}$ /PP inputs to configure the C/Q and DO drivers in push-pull, PNP, or NPN modes (Table 3) In this mode, toggle TXEN, TX, and LO to switch the C/Q and DO outputs.

#### **Configurable Drivers (SPI Mode)**

In SPI operation, the C/Q and DO drivers can be configured independently. Set the bits in the CQConfig register to configure the C/Q driver, enable/disable the weak pull-up and pull-down currents on C/Q. Set the bits in the DIOConfig register to configure the DO driver and enable/ disable the weak pull-up and pull-down currents on DO. The C/Q and DO drivers can be disabled by setting the CQ\_Dis and DO\_Dis bits. Driver outputs are high impedance and power dissipation is reduced when these bits are set. See the <u>Register Functionality</u> section for more information on configuring the drivers.

For IO-Link operation, TX, TXEN, and RX are the UART interface to control C/Q communication. Set CQ\_Dis =  $CQ_Q = 0$  and drive TX and TXEN inputs for C/Q driver control.

For lower rate switching on the C/Q and DO drivers, register bits can be used for C/Q and DO control. For bit control, drive TXEN, TX, and LO high and use the CQ\_Q and DO\_Q bits to control the C/Q and DO driver states. The CQ\_Dis and DO\_Dis bits are used to enable/disable the drivers in this mode.

### C/Q Driver Enable/Disable

In pin-mode, the C/Q driver is enabled/disabled with the TXEN input. Drive TXEN high to enable the C/Q driver. C/Q is the logic inverse of the TX input.

In SPI mode, the C/Q driver can also be enabled/disabled, configured, and controlled in the CQConfig register.

#### C/Q Current Limit

The C/Q driver is optimized for driving large capacitive loads and dynamic impedances like incandescent lamps. In pin-mode, the driver current limit is selectable by setting the CLK/TXEN/200MA input high or low. Set CLK/TXEN/200MA low for 100mA maximum load current. Set CLK/TXEN/200MA high for a 200mA maximum load current.

In SPI operation, the maximum driver current limit is selectable as 50mA, 100mA, 200mA, or 250mA by setting the CL1 and CL0 bits in the CURRLIM register.

#### **C/Q Driver Fault Detection**

The MAX14827A senses a fault condition on the C/Q driver when it detects a short circuit for longer than the blanking time. A short condition exists when the C/Q driver's load current exceeds the current limit. In SPI mode, both the current limit and blanking time may be configured.

In pin-mode, the  $\overline{IRQ}/\overline{OC}$  output asserts low when a short circuit fault occurs on C/Q or DO. In SPI mode, the

C/QFault and C/QFaultInt bits are set and  $\overline{IRQ}/\overline{OC}$  asserts.

When a short-circuit event occurs on C/Q, the driver can either be set to continue supplying the selected current until the device enters thermal shutdown or to enter autoretry mode when an overcurrent event occurs. In autoretry mode the driver is automattically disabled after the current blanking time and is then re-enabled.

#### C/Q Receiver Output (RX)

RX is the output of the C/Q receiver. RX is the inverse logic of the C/Q input.

In pin-control mode, the C/Q receiver is always on.

In SPI mode, the receiver can be disabled by setting the Rx\_Dis bit in the CQConfig register. RX is high impedance when Rx\_Dis is set. Note that the CQLvI bit in the Status register is invalid when the Rx\_Dis bit is set.

When operating in multiplexed mode, SDO/RX/THSH is the output of the C/Q receiver. In this mode, SDO/RX/THSH is high impedance when CS/PP is high and Rx\_Dis bit is set.

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

#### C/Q Receiver Threshold

The IO-Link standard defines device operation with a sensor supply between 18V and 30V. Industrial sensors, however, commonly operate with supply voltages as low as 9V. The MAX14827A C/Q receiver supports operation with lower supply voltages by scaling the receiver thresholds when V24 is less than 18V (V<sub>24</sub> < 18V).

#### **DO Driver**

In pin-mode, the DO driver is always enabled. DO is the logic inverse of the LO input.

In SPI mode, the DO driver can be enabled/disabled, configured, and controlled in the DIOConfig register.

#### **DO Current Limit**

The DO driver is optimized for driving large capacitive loads and dynamic impedances like incandescent lamps. In pin-control mode, the driver current limit is selectable by setting the CLK/TXEN/200MA input high or low. Set CLK/TXEN/200MA low for 100mA maximum load current. Set CLK/TXEN/200MA high for a 200mA maximum load current.

In SPI operation, the maximum driver current limit is selectable as 50mA, 100mA, 200mA, or 250mA by setting the CL1 and CL0 bits in the CURRLIM register.

#### **DO Fault Detection**

The MAX14827A senses a fault condition on the DO output when it detects a short circuit for longer than the blanking time. A short condition exists when the DO driver's load current exceeds the current limit. In SPI mode, both the current limit and blanking time may be configured.

In pin-mode, the  $\overline{IRQ/OC}$  output asserts low when a short circuit fault occurs on C/Q or DO. In SPI mode, the DoFault and DoFaultInt bits are set and  $\overline{IRQ/OC}$  asserts.

When a short-circuit event occurs on DO, the driver can either be set to continue supplying the selected current until the device enters thermal shutdown or to enter autoretry mode when an overcurrent event occurs. In autoretry mode the driver is automattically disabled after the current blanking time and is then re-enabled.

#### DO and C/Q Tracking

In SPI mode, the DO driver can be configured to track the C/Q driver. Set the CQDOPar bit in the CQConfig register to enable this functionality. When the DO driver is set to track C/Q, both C/Q and DO switch as a function of the TX and TXEN inputs or CQ\_Q bit.

In pin-mode, or when CQDOPar is 0, C/Q and DO operate independently.

### **Reverse-Polarity Protection**

The MAX14827A is protected against reverse-polarity connections on V24, C/Q, DO, DI, and GND. Any combination of these pins can be connected to DC voltages up to 65V (max), resulting in a current flow of less than 1mA.

Ensure that the maximum voltage between any of these pins does not exceed 65V.

#### **Driver Short-Circuit Detection**

The MAX14827A monitors the DO and C/Q driver outputs for overcurrent and driver overheating conditions.

In pin-mode, the driver short-circuit current limit is set with the CLK/TXEN/200mA input.  $\overline{IRQ}/\overline{OC}$  asserts when an overcurrent or overheating condition occurs on either the C/Q or DO driver.  $\overline{IRQ}/\overline{OC}$  deasserts when the overcurrent or overheating condition is removed.

In SPI mode, the DO and C/Q are independently monitored. Driver current limits for both drivers are set using the CL1 and CL0 bits in the CURRLIM register. When an overcurrent or overheating condition occurs on C/Q, the CQFault and CQFaultInt bits are set and IRQ/OC asserts. When an overcurrent or overheating condition occurs on DO, the DOFault and DOFaultInt bits are set. The CQFault and DOFault bits are cleared as soon as the overcurrent or overheating conditions on the C/Q and DO drivers are removed. IRQ/OC deasserts and the CQFaultInt and DOFaultInt bits are cleared only when the INTERRUPT register is read.

#### 5V and 3.3V Linear Regulators

The MAX14827A includes two internal regulators to generate 5V (V5) and 3.3V (V33).

The V5 regulator is capable of driving external loads up to 30mA, including device and 3.3V LDO current consumption. To drive larger loads, use an external pass transistor to generate the required 5V. When using an external transistor, connect REG to the base of the transistor to regulate the voltage and connect V5 to the emitter (Figure 10).

When the internal 5V linear regulator is not used, V5 is the supply input for the internal analog and digital functions and must be supplied externally. Ensure that V5 is present for normal operation.

The 3.3V regulator is capable of driving external loads up to 30mA. In SPI mode, the 3.3V LDO can be enabled/ disabled by setting the V33Dis bit in the Mode register.

V5 and V33 are not protected against short circuits.

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### **Power-Up**

The C/Q and DO driver outputs are high impedance when V24, V5, VL, and/or V33 voltages are below their respective undervoltage thresholds during power-up.

The drivers are automatically disabled if V24, V5, or VL falls below its threshold.

#### Low Voltage and Undervoltage Detection

In SPI mode, the device monitors the V24 supply for low voltage and undervoltage conditions. Low-voltage warnings must be enabled in the MODE register.

When V<sub>24</sub> falls below the 16V (typ) low-voltage warning threshold, the V<sub>24W</sub> bit in the STATUS register is set. If V24WEn is set to 1, the V24WInt interrupt bit is also set and  $\overline{IRQ/OC}$  asserts.

When V24 falls below the 7.4V (typ) undervotlage lockout (UVLO) threshold, the UV24 bit in the STATUS register is set. Similarly, the UV24Int bit in the INTERRUPT register is set and  $\overline{IRQ/OC}$  asserts. UVLO monitoring and interrupts cannot be disabled.

#### Wake-Up Detection

The MAX14827A detects an IO-Link wake-up condition on the C/Q line in push-pull, high-side (PNP), or low-side (NPN) operation modes. A wake-up condition is detected when the C/Q output is shorted for  $80\mu$ s (typ). WU pulses low for 200µs (typ) when the device detects a wake-up pulse on C/Q (Figure 5).

In SPI mode, the WuInt bit in the INTERRUPT registeris set and  $\overline{\text{IRQ}/\text{OC}}$  asserts when an IO-Link wake-up event is detected.

Wake-up detection can be disabled in SPI mode by setting the WU\_Dis bit in the MODE register to 1. Wake-up detection cannot be disabled in pin-mode.

The device includes a wake-up detection algorithm to avoid false wake-up detection on C/Q. The false wake-up blanking time is defined by the current limit blanking time. In pin-mode, this is  $128\mu$ s. In SPI-mode, this is set by the CL\_BL0 and CL\_BL1 bits in the CURRLIM reigster.

#### **Thermal Protection and Considerations**

The internal LDOs and drivers can generate more power than the package for the devices can safely dissipate. Ensure that the driver and LDO loading is less than the package can dissipate. Total power dissipation for the device is calculated using the following equation:

$$P_{TOTAL} = P_{C/Q} + P_{DO} + P_{V5} + P_{33} + P_{24} + (2 \times P_{PU}) + (2 \times P_{PD})$$

where  $P_{C/Q}$  is the power generated in the C/Q driver,  $P_{DO}$  is the power dissipated by the DO driver,  $P_{V5}$  and  $P_{V33}$  are the power generated by the LDOs,  $P_{24}$  is the quiescent power generated by the device, and  $P_{PU}$  and  $P_{PD}$  are the power generated in the C/Q and DO weak pullup/ pulldown current sources/sinks, respectively.

Ensure that the total power dissipation is less than the limits listed in the <u>Absolute Maximum Ratings</u> section.

Use the following to calculate the power dissipation (in mW) due to the C/Q driver:

$$P_{C/Q} = [I_{C/Q}(max)]^2 \times R_O$$

where RO driver on-resistance.

Calculate the internal power dissipation of the DO driver using the following equation:

$$P_{DO} = [I_{DO}(max)]^2 \times R_O$$

where RO driver on-resistance.

Calculate the power dissipation in the 5V LDO,  $V_5$ , using the following equation:

$$P_5 = (V_{24} - V_5) \times I_5$$

where  $I_5$  includes the  $I_{33}$  current sourced from V33.

Calculate the power dissipated in the 3.3V LDO, V33, using the following equation:

$$P_{33} = 1.7V \times I_{LOAD33}$$

Calculate the quiescent power dissipation in the device using the following equation:

$$P_{24} = I_{24}(max) \times V_{24}(max)$$

If the weak current sinks/sources are enabled, calculate their associated power dissipation as:

$$P_{PD} = I_{PD}(max) \times V_{C/Q} (max)$$
$$P_{PU} = I_{PU}(max) \times [V_{24} - V_{C/Q}](max)$$

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#### **Overtemperature Warning**

In SPI mode, the device generates interrupts when the junction temperature of any of the drivers (C/Q or DO) exceeds +140°C (typ) warning threshold. The TempW bit in the STATUS register is set and the TempWInt in the INTERRUPT register is set and  $\overline{IRQ/OC}$  asserts under these conditions.

The TempW bit is cleared when the die temperature falls to +125°C. The INTERRUPT register must be read to clear the TempWInt bit and deassert  $\overline{IRQ}/\overline{OC}$ .

The device continues to operate normally unless the die temperature reaches the +165°C thermal shutdown threshold, when the device enters thermal shutdown.

The device does not generate overtemperature warnings when operating in pin-mode.

#### **Thermal Shutdown**

The C/Q and DO drivers, and the V5 and V33 regulators are automatically switched off when the junction temperature exceeds the +165°C (typ) thermal shutdown threshold. SPI communication and and the internal regulators are not disabled during thermal shutdown. In SPI mode, the ThShut bit in the STATUS register and the ThShutInt in the INTERRUPT register are set.

Regulators are automatically switched on when the internal die temperature falls below the thermal shutdown threshold plus hysteresis. If the internal V5 regulator is used, the internal registers return to their default state when the V5 regulator is switched back on.

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### **Mode Selection Table**

OPERATING MODE	SPI/ PIN	UARTSEL	ENMPX BIT	CS/PP	PIN NAME	PIN FUNCTION	FUNCTION
					SDI/TX/NPN	NPN	Parallel configuration/monitoring
					SDO/RX/THSH	THSH	Parallel configuration/monitoring
					CLK/TXEN/200MA	200MA	Parallel configuration/monitoring
					CS/PP	PP	Parallel configuration/monitoring
PIN	L	x	x	LOW OR	IRQ/OC		Parallel configuration/monitoring
	L			HIGH	RX	C/Q RX	Parallel configuration/monitoring/ UART communication
					ТХ	C/Q TX	Parallel configuration/monitoring/ UART communication
					TXEN	C/Q TXEN	Parallel configuration/monitoring/ UART communication
					SDI/TX/NPN	SDI	SPI configuration/monitoring
PARALLEL UART + SPI	н	L	0		SDO/RX/THSH	SDO	SPI configuration/monitoring
					CLK/TXEN/200MA	CLK	SPI configuration/monitoring
				LOW OR HIGH	CS/PP	CS	SPI configuration/monitoring
					IRQ/OC	ĪRQ	SPI configuration/monitoring
					RX	C/Q RX	UART communication
					ТХ	C/Q TX	UART communication
					TXEN	C/Q TXEN	UART communication
					SDI/TX/NPN	SDI	SPI configuration/monitoring
					SDO/RX/THSH	SDO	SPI configuration/monitoring
					CLK/TXEN/200MA	CLK	SPI configuration/monitoring
				L	CS/PP	LOW	SPI configuration/monitoring
					<b>IRQ</b> /OC	ĪRQ	SPI configuration/monitoring
					RX	C/Q RX	UART communication
					ТХ	C/Q TX	UART communication
MULTIPLEXED	н	н	0		TXEN	C/Q TXEN	UART communication
UART/SPI					SDI/TX/NPN	C/Q TX	UART communication
					SDO/RX/THSH	C/Q RX	UART communication
					CLK/TXEN/200MA	C/Q TXEN	UART communication
				Н	CS/PP	HIGH	
					IRQ/OC	ĪRQ	SPI configuration/monitoring
					RX	C/Q RX	Active
					ТХ	C/Q TX	Ignored
					TXEN	C/Q TXEN	Ignored

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# Mode Selection Table (continued)

OPERATING MODE	SPI/ PIN	UARTSEL	ENMPX BIT	CS/PP	PIN NAME	PIN FUNCTION	FUNCTION
					SDI/TX/NPN	SDI	SPI configuration/monitoring
					SDO/RX/THSH	SDO	SPI configuration/monitoring
					CLK/TXEN/200MA	CLK	SPI configuration/monitoring
		0			CS/PP	CS	SPI configuration/monitoring
		0			IRQ/OC	ĪRQ	SPI configuration/monitoring
					RX		Active
					ТХ		Ignored
MULTIPLEXED	н		1	LOW OR	TXEN		Ignored
UART/SPI	11			HIGH	SDI/TX/NPN	C/Q TX	UART communication
					SDO/RX/THSH	C/Q RX	UART communication
					CLK/TXEN/200MA	C/Q TXEN	UART communication
		1			CS/PP		Not used
					IRQ/OC	ĪRQ	SPI monitoring
					RX		Active
					ТХ		Ignored
					TXEN		Ignored

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### **Register Functionality**

The devices have four 8-bit-wide registers for configuration and monitoring (Table 1).

REGISTER	ADD	R/W	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
INTERRUPT	00h	R	ThShutInt	WuInt	DoFaultInt	CQFaultInt	V24WInt	UV24Int	-	TempWInt
STATUS	01h	R	ThShut	DiLvl	DoFault	CQFault	V24W	UV24	CQLvI	TempW
MODE	02h	R/W	RST	WU_Dis	V33_Dis	ENMPX	V24WEn	CQFil	LED2b	LED1b
CURRLIM	03h	R/W	CL1	CL0	CLDis	CL_BL1	CL_BL0	TAr1	TAr0	ArEn
CQConfig	04h	R/W	Rx_Dis	CQ_WPD	CQ_WPU	CQDOPar	CQ_NPN	CQ_PP	CQ_Q	CQ_Dis
DIOConfig	05h	R/W	DI_Dis	DO_WPD	DO_WPU	DO_AV	DO_NPN	DO_PP	DO_Q	DO_Dis

### Table 4. Register Summary

### INTERRUPT Register [A2, A1, A0] = [000]

Bit	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit Name	ThShutInt	Wulnt	DoFaultInt	CQFaultInt	V24WInt	UV24Int	-	TempWInt
Read/Write	R	R	R	R	R	R	R	R
POR State	0	0	0	0	0	0	0	0
Reset Upon Read	N	Ν	Ν	N	Ν	Ν	Ν	N

The INTERRUPT register reflects current state of various fault conditions. The  $\overline{IRQ/OC}$  output asserts when any of the bits in the INTERRUPT register is set. INTERRUPT register bits are latched and are not cleared when the initiating condition is removed. Reading the INTERRUPT register clears all the bits and deasserts  $\overline{IRQ/OC}$ .  $\overline{IRQ/OC}$  reasserts only when another fault condition occurs.

BIT	NAME	DESCRIPTION
7	ThShutInt	<ul> <li>Thermal Shutdown Interrupt</li> <li>1: This bit is set when the MAX14827A has entered thermal shutdown mode. Once set, this bit is not cleared until the register is read. The current status of the thermal shutdown condition can be read in the Status register.</li> <li>0: The MAX14827A is not in thermal shutdown.</li> </ul>
6	Wulnt	Wake-Up Event Interrupt 1: This bit is set when an IO-Link wake-up condition is detected on the C/Q line. 0: No wake-up condition is detected. The wake-up interrupt can be disabled by setting the WuDis bit to 1.

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### INTERRUPT Register [A2, A1, A0] = [000] (continued)

BIT	NAME	DESCRIPTION
5	DoFaultInt	<ul> <li>DO Driver Fault Interrupt</li> <li>1: This bit is set when a fault occurs on the DO driver (over current or over heating). Once set, this bit is not cleared until the register is read. The current status of the thermal shutdown condition can be read in the Status register.</li> <li>0: No fault on the DO driver.</li> </ul>
4	CQ_FaultInt	<ul> <li>C/Q Driver Fault Interrupt</li> <li>1: This bit is set when a fault occurs on the C/Q driver (over current or over heating). Once set, this bit is not cleared until the register is read. The current status of the thermal shutdown condition can be read in the Status register.</li> <li>0: No fault on the C/Q driver.</li> </ul>
3	V24WInt	<ul> <li>V24 Low Voltage Warning Interrupt</li> <li>1: This bit is set when V<sub>24</sub> falls below the IO-Link low-voltage warning threshold fault (V<sub>24</sub> &lt; V<sub>24W</sub>). Once set, this bit is not cleared until the register is read. The current status of the thermal shutdown condition can be read in the Status register.</li> <li>0: V<sub>24</sub> is greater than the low-voltage warning threshold.</li> </ul>
2	UV24Int	<ul> <li>V24 Supply Undervoltage Interrupt</li> <li>1: This bit is set when V<sub>24</sub> falls below the UVLO threshold (V<sub>24</sub> &lt; V<sub>24UVLO</sub>). Once set, this bit is not cleared until the register is read. The current status of the thermal shutdown condition can be read in the Status register.</li> <li>0: V<sub>24</sub> is greater than the UVLO threshold.</li> </ul>
1	_	This bit is not used.
0	TempWInt	<ul> <li>Overtemperature Warning Interrupt</li> <li>1: This bit is set when the die temperature exceeds the warning threshold (T<sub>J</sub> &gt; T<sub>WRN</sub>). Once set, this bit is not cleared until the register is read. The current status of the thermal shutdown condition can be read in the Status register.</li> <li>0: The die temperature has not exceeded the overtemperature warning threshold.</li> </ul>

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Bit	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit Name	ThShut	DiLvl	DoFault	CQFault	V24W	UV24	CQLvI	TempW
Read/Write	R	R	R	R	R	R	R	R
POR State	0	0	0	0	0	0	0	0
Reset Upon Read	N	N	N	N	N	N	N	N

### STATUS Register [A2, A1, A0] = [001]

The Status register reflects current state of various IC functions.

BIT	NAME	DESCRIPTION
7	ThShut	<ul><li>Thermal Shutdown Status</li><li>1: This bit is set when the MAX14827A has entered thermal shutdown mode.</li><li>0: This bit is cleared automatically when the device exits thermal shutdown.</li></ul>
6	DiLvl	<b>DI Logic Level</b> 1: This bit is set when the DI voltage is a logic high (V <sub>DI</sub> < V <sub>TL</sub> ). 0: This bit is clear when the DI voltage is a logic low (V <sub>DI</sub> > V <sub>TH</sub> ).
5	DoFault	<b>DO Driver Fault Status</b> <ol> <li>This bit is set when a fault occurs on the DO driver (over current or over heating).</li> <li>This bit is cleared automatically when the fault on DO is removed.</li> </ol>
4	CQ_Fault	<ul><li>C/Q Driver Fault Status</li><li>1: This bit is set when a fault occurs on the C/Q driver (over current or over heating).</li><li>0: This bit is cleared automatically when the fault on C/Q is removed.</li></ul>
3	V24W	<ul> <li>V24 Low Voltage Warning Status</li> <li>1: This bit is set when V24 falls below the IO-Link low-voltage warning threshold (V<sub>24</sub> &lt; V<sub>24W</sub>).</li> <li>0: This bit is cleared automatically when V24 rises above the low-voltage warning threshold.</li> </ul>
2	UV24	<ul> <li>V24 Supply Status</li> <li>1: This bit is set when V24 falls below the UVLO threshold (V<sub>24</sub> &lt; V<sub>24UVLO</sub>).</li> <li>0: This bit is cleared automatically when V24 rises above the UVLO threshold.</li> </ul>
1	CQLvI	<ul> <li>C/Q Logic Level</li> <li>1: This bit is set when the C/Q voltage is a logic high (V<sub>C/Q</sub> &lt; V<sub>TL</sub>).</li> <li>0: This bit is clear when the C/Q voltage is a logic low (V<sub>C/Q</sub> &gt; V<sub>TH</sub>).</li> </ul>
0	TempW	<b>Overtemperature Warning</b> 1: This bit is set when the die temperature exceeds the warning threshold ( $T_J > T_{WRN}$ ). 0: This bit is cleared automatically when the when the die temperature falls below the warning threshold and hysteresis ( $T_J < T_{WRN} - T_{WRN}_{HYST}$ ).

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### MODE Register [A2, A1, A0] = [010]

Bit	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit Name	RST	WU_Dis	V33_Dis	ENMPX	V24WEn	CQFil	LED2b	LED1b
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR State	0	0	0	0	0	0	0	0
Reset upon Read	N	N	N	N	N	N	N	N

Use the Mode register to configure the MAX14827A and manage the 3.3V LDO.

BIT	NAME	DESCRIPTION
7	RST	<ul> <li>Register Reset</li> <li>1: Reset all registers to their default power-up state. The Status register is cleared and IRQ deasserts (if asserted) when RST = 1. Interrupts are not generated while RST = 1.</li> <li>0: Normal operation.</li> </ul>
6	WU_Dis	Wake-Up Interrupt Disable/Enable 1: Wake-up detection is disabled. 0: Enable IO-Link wake-up detection.
5	V33_Dis	<ul><li>V33 Enable/Disable</li><li>1: Disable the V33 linear regulator.</li><li>0: Enable the V33 linear regulator.</li></ul>
4	ENMPX	<ul> <li>Enable/Disable SPI/UART Multiplexing</li> <li>1: Enable UART multiplexing on SPI interface pins. See the Mode Selection Table for more information.</li> <li>0: Disable UART multiplexing on SPI interface pins.</li> </ul>
3	V24WEn	<ul> <li>V24 Undervoltage Warning Enable</li> <li>1: Enable the V24 undervoltage warning interrupt. V24WInt is set when V24 fall below the UVLO threshold.</li> <li>0: Disable the V24 undervoltage warning interrupt.</li> </ul>
2	CQFil	<ul><li>C/Q Deglitch Filter Enable/Disable</li><li>1: Deglitch filter is disabled on RX.</li><li>0: Deglitch filter is enabled on RX.</li></ul>
1	LED2b	<b>LED2 Driver Logic</b> 1: Set the LED2 output high. 0: Set the LED2 output low.
0	LED1b	<b>LED1 Driver Logic.</b> 1: Set the LED1 output high. 0: LED1 output is driven by the LED1IN logic input.

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Bit	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit Name	CL1	CL0	CL_Dis	CL_BL1	CL_BL0	TAr1	TAr0	ArEN
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR State	0	0	0	0	0	0	0	0
Reset Upon Read	N	N	N	N	N	N	Ν	Ν

### CURRLIM Register [A2, A1, A0] = [011]

The CURRLIM register sets the C/Q and DO driver current limits and the fixed off-time once the drivers have exceeded their individual thermal shutdown thresholds.

BIT	NAME	DESCRIPTION
7	CL1	<b>Driver Current Limit</b> Set the CL1 and CL0 bits to select the active current limit for the C/Q and DO drivers when CL_Dis = 0.
6	CL0	<ul> <li>00: Driver current limit is set to 50mA</li> <li>01: Driver current limit is set to 100mA</li> <li>10: Driver current limit is set to 200mA</li> <li>11: Driver current limit is set to 250mA</li> </ul>
5	CL_Dis	<ul> <li>Driver Current Limit Disable/Enable</li> <li>1: Disable the driver current limit for the C/Q and DO drivers.</li> <li>0: Enable the driver current limit (as set by the CL1 and CL0 bits).</li> </ul>
4	CL_BL1	<b>Current Limit Blanking Time</b> Set the CL_BL1 and CL_BL0 bits to select the minimum blanking time to signal a cur- rent limit or thermal fault.
3	CL_BL0	00: Blanking time is 128μs 01: Blanking time is 500μs 10: Blanking time is 1ms 11: Blanking time is 5ms
2	TAr1	<b>Auto-Retry Fixed Off-Time</b> Set the TAr1 and TAr0 bits to select the fixed driver off-time after a fault has been generated when auto-retry functionality is enabled (ArEn = 1). The driver is re-enabled automatically after the fixed off-delay.
1	TAr0	00: Fixed off-time is 50ms 01: Fixed off-time is 100ms 10: Fixed off-time is 200ms 11: Fixed off-time is 500ms
0	ArEN	<ul> <li>Auto-Retry Fixed Off-Time Enable/Disable</li> <li>1: Fixed off-time functionality is enabled. C/Q and DO drivers are disabled for a fixed time after an overcurrent or thermal fault occurs. The driver is re-enabled automatically after the fixed off-delay.</li> <li>0: Fixed off-time functionality is disabled. The driver is re-enabled after temperature falls below the thermal hysteresis.</li> </ul>

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Bit	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit Name	RX_Dis	CQ_WPD	C/Q_WPU	C/QDOPar	C/Q_NPN	CQ_PP	CQ_Q	CQ_Dis
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR State	0	0	0	0	0	0	0	1
Reset Upon Read	N	N	N	N	N	N	N	Ν

### CQConfig Register [A2, A1, A0] = [100]

Use the CQConfig register to control the C/Q driver and receiver parameters. All bits in the CQConfig register are read-write.

BIT	NAME	DESCRIPTION
7	RX_Dis	<b>Receiver Disable/Enable</b> 1: The RX receiver output is disabled. RX is high impedance when disabled. 0: RX is enabled.
6	CQ_WPD	<ul><li>C/Q Weak Pull-Down Enable</li><li>1: Enable the weak pull-down current sink on the C/Q driver.</li><li>0: Disable the weak pull-down current sink on the C/Q driver.</li></ul>
5	CQ_WPU	<ul> <li>C/Q Weak Pull-Up Enable</li> <li>1: Enable the weak pull-up current source on the C/Q driver.</li> <li>0: Disable the weak pull-up current source on the C/Q driver.</li> </ul>
4	CQDOPar	<ul> <li>C/Q and DO Driver Tracking</li> <li>1: Enable C/Q and DO tracking. In this mode, both C/Q and DO switch as a function of the TX input or the CQ_Q bit.</li> <li>0: C/Q and DO operate independently.</li> </ul>
3	CQ_NPN	<ul> <li>C/Q Driver NPN/PNP Mode</li> <li>1: Enable NPN operation (when CQ_PP = 0) on the C/Q driver.</li> <li>0: Enable PNP operation (when CQ_PP = 0) on the C/Q driver.</li> <li>CQ_NPN is ignored when CQ_PP = 1.</li> </ul>
2	CQ_PP	<b>C/Q Driver Push-Pull Mode</b> <ol> <li>Enable push-pull operation on the C/Q driver.</li> <li>Enable open-drain (PNP or NPN mode) operation on the C/Q driver.</li> </ol>
1	CQ_Q	<ul> <li>C/Q Driver Output Logic</li> <li>1: Set the C/Q driver high (push-pull mode), set the C/Q PNP switch on (PNP mode), or set the C/Q NPN switch off (NPN mode). See Table 1.</li> <li>0: CQ is high impedance when CQ_Q = 0 and TXEN is low (or CQ_Dis = 1). CQ logic is the inverse of TX logic when TXEN is high (and CQ_Dis = 0) and CQ_Q = 0. See Table 1.</li> </ul>
0	CQ_Dis	<ul> <li>C/Q Driver Disable/Enable</li> <li>1: Disable the C/Q driver, regardless of the state of the TXEN input. The driver is high impedance in this mode.</li> <li>0: Status of the C/Q driver is determined by the TXEN input or CQ_Q bit.</li> </ul>

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

Bit	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Bit Name	DI_Dis	DO_WPD	DO_WPU	DO_AV	DO_NPN	DO_PP	DO_Q	DO_Dis
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR State	0	0	0	0	0	0	0	1
Reset Upon Read	N	N	N	N	N	N	N	Ν

### DIOConfig Register [A2, A1, A0] = [101]

Use the DIOConfig register to control the DI and DO interfaces. All bits in the DIOConfig register are read-write.

BIT	NAME	DESCRIPTION
7	DI_Dis	<ul> <li>DI Receiver Enable/Disable</li> <li>1: The DI receiver is disabled. LI is high impedance when the DI receiver is disabled.</li> <li>0: DI receiver is enabled.</li> </ul>
6	DO_WPD	<ul><li>DO Weak Pulldown Enable</li><li>1: Enable the weak pull-down current sink on the DO driver.</li><li>0: Disable the weak pull-down current sink on the DO driver.</li></ul>
5	DO_WPU	<b>DO Weak Pullup Enable</b> 1: Enable the weak pull-up current source on the DO driver. 0: Disable the weak pull-up current source on the DO driver.
4	DO_AV	<ul> <li>DO Antivalent Operation</li> <li>1: Enable antivalent operation on the C/Q and DO outputs. In this mode, DO switches as a function of the LO input or the DO_Q bit, but with opposite logic. If CQDOPar = 1, both C/Q and DO switch as a function of TX and/or CQ_Q, but with opposite logic.</li> <li>0: C/Q and DO switch with normal polarity.</li> </ul>
3	DO_NPN	<b>DO Driver NPN/PNP Mode</b> 1: Enable NPN operation (when DO_PP = 0) on the DO driver. 0: Enable PNP operation (when DO_PP = 0) on the DO driver. DO_NPN is ignored when DO_PP = 1.
2	DO_PP	<b>DO Driver Push-Pull Mode</b> <ol> <li>Enable push-pull operation on the DO driver.</li> <li>Enable open-drain (PNP or NPN mode) operation on the DO driver.</li> </ol>
1	DO_Q	<ul> <li>DO Driver Output Logic</li> <li>1: Set the DO driver high (push-pull mode), set the DO PNP switch on (PNP mode), or set the DO NPN switch off (NPN mode). See Table 1.</li> <li>0: DO logic is the inverse of LO logic when DO_Dis = 0 and DO_Q = 0. See Table 1.</li> </ul>
0	DO_Dis	<ul> <li>DO Driver Disable/Enable</li> <li>1: Disable the DO driver. DO is high impedance when disabled.</li> <li>0: State of the DO driver is determined by the LO input or the DO_Q bit.</li> </ul>

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### **SPI Interface**

The device communicates through an SPI-compatible 4-wire serial interface. The MAX14827A supports burst read/write access. The maximum SPI clock rate for the device is 12MHz. The SPI interface complies with clock polarity CPOL = 0 and clock phase CPHA = 0 (see Figure 7 and Figure 8).

The SPI interface is not available when  $\mathsf{V}_5$  or  $\mathsf{V}_L$  are not present.

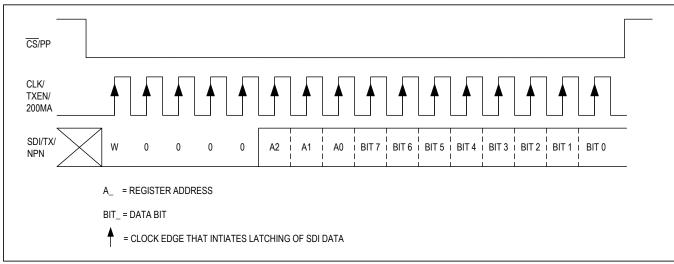


Figure 7. SPI Write Cycle

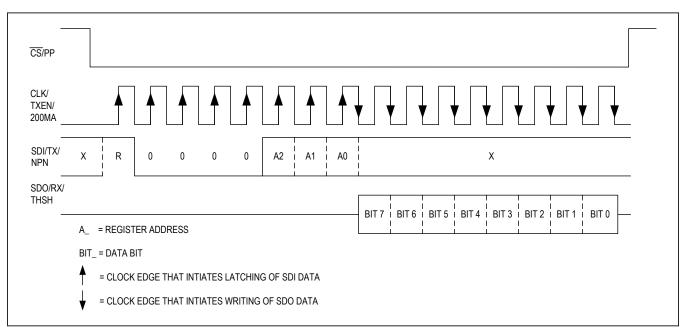


Figure 8. SPI Read Cycle

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

#### **SPI Burst Access**

Burst access allows writing or reading in one block, by only defining the initial register address in the SPI command byte. Once the initial SPI address is received, the MAX14827A automatically increments the register after each SPI data byte. Efficient programming of multiple consecutive registers is thus possible. Chip select,  $\overline{CS}$ / PP, must be kept low during the whole write/read cycle.

The SPI clock continues clocking throughout the burst access cycle. The burst cycle ends when the SPI master pulls  $\overline{\text{CS}}/\text{PP}$  high.

### **Applications Information**

#### **Microcontroller Interfacing**

The logic levels of the microcontroller interface I/Os are defined by V<sub>L</sub>. Apply a voltage from 2.5V to 5.5V to VL for normal operation. Logic outputs are supplied by VL.

The device can be configured for simultaneous or multiplexed UART communication. When configured for a multipexed UART interface, the SPI interface and UART interface pins are shared. See the Mode Selection Table for more information.

#### **Transient Protection**

Inductive load switching, ESD, bursts, and surges create high transient voltages. V24, C/Q, DI, and DO should be protected against high overvoltage and undervoltage transients. Positive voltage transients on V24, C/Q, DO, and DI must be limited to +70V relative to GND. Negative voltage transients must be limited to -70V relative to V24. Use protection diodes on C/Q, DO, and DI as shown in Figure 9.

For standard ESD and burst protection demanded by the IO-Link specification, small package TVS can be used (like the uClamp3603T or the SPT01-335). If higher level surge ratings need to be achieved (IEC 61000-4-5  $\pm$ 1kV/ 42 $\Omega$ ), SMAJ33A or SMBJ36A TVS protectors can also be used.

# Using an External Transistor with the 5V Regulator

The internal 5V regulator (V5) can provide up to 30mA of total load current (including the current on to the V33 LDO) when V5 is connected to REG. To achieve larger

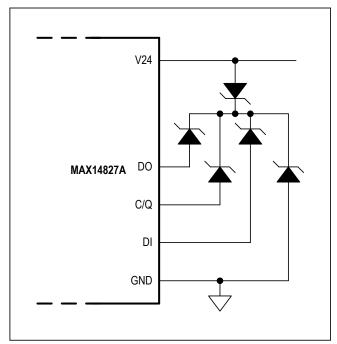


Figure 9. MAX14827A Operating Circuit with TVS Protection

load currents or to shunt the power dissipation away from the MAX14827A, an external NPN transistor can be connected as shown in Figure 10.

Select an NPN transistor with high VCE voltage to support the max L+ supply voltage. In order to protect the NPN transistor against reverse polarity of the L+/L- supply terminals, connect a silicon or a Schottky diode in series with the NPN transistor's collector that has a reverse voltage capability large enough for reverse connected L+/L-. A 1 $\mu$ F capacitor on the V5 is required for stability.

# Using an Step-Down Regulator with the 5V Regulator

To decrease power dissipation in the MAX14827A, V5 can be powered by an external step-down regulator. Connect the external regulator's output to the V5 input and leave REG unconnected. (Figure 11)

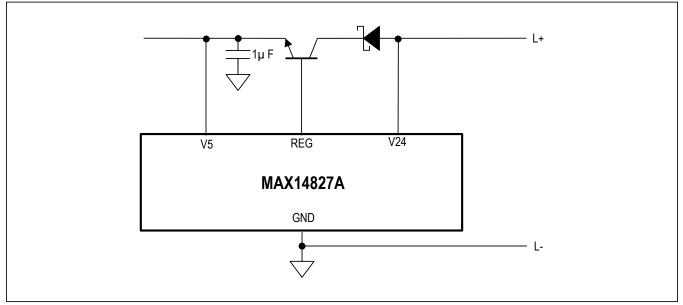


Figure 10. Using an External NPN Transistor with the 5V Regulator

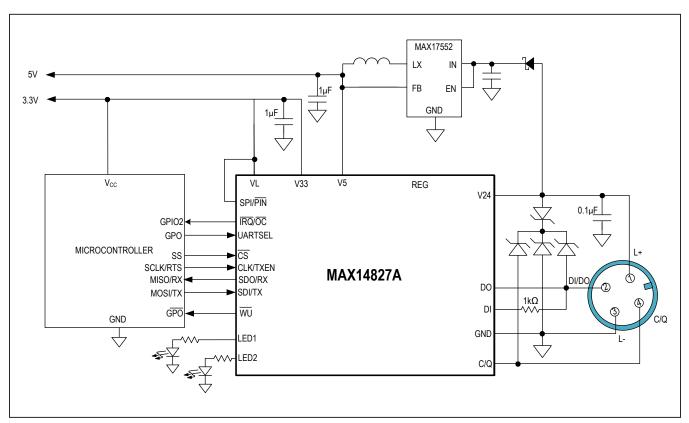


Figure 11. Using an External Step-Down with the 5V Regulator

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### Shared SPI/UART Interface

<u>Figure 12</u> is an example of the use of a minimum pincount microcontroller. A microcontroller serial port, which supports both UART and SPI functions, is used for managing both transceiver control (SPI) and IO-Link data communication (UART). The microcontroller's shared UART and SPI interface pins are multiplexed. The transceiver's SPI is typically only used for configuration at power-up and occasionally afterwards for reconfiguration, and diagnostics. During an IO-Link master-device communication cycle, the idle time on the C/Q interface can be used for SPI activity. This is possible by slightly increasing the IO-Link device' minimum cycle time.

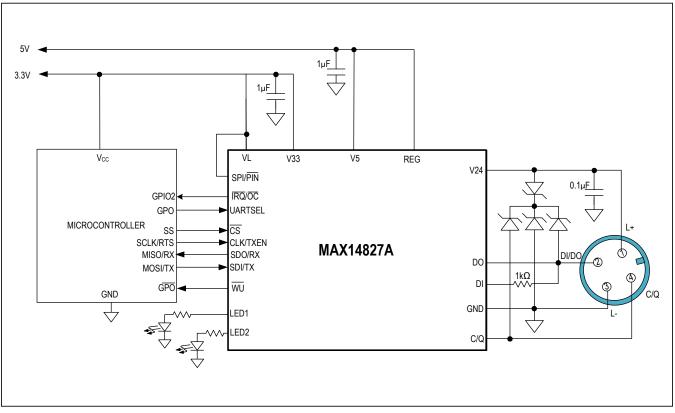


Figure 12. Multiplexed SPI/UART Mode Configuration

# Low-Power, Ultra-Small, Dual Driver, **IO-Link Device Transceiver**

# **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX14827AATG+	-40°C to +125°C	24 TQFN-EP*
MAX14827AATG+T	-40°C to +125°C	24 TQFN-EP*
MAX14827AAWA+	-40°C to +125°C	25 WLP
MAX14827AAWA+T	-40°C to +125°C	25 WLP

+Denotes a lead(Pb)-free/RoHS-compliant package. \*EP = Exposed pad. T = Tape & Reel.

# Chip Information PROCESS: BiCMOS

# Low-Power, Ultra-Small, Dual Driver, IO-Link Device Transceiver

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	7/16	Initial release	—
1	9/16	Added DI_Dis information	30, 36
2	3/19	Updated the <i>Typical Application Circuit, Pin Description</i> and <i>Wake-Up Detection</i> sections, and Figures 11 and 12	1, 20, 26, 39–40

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at https://www.maximintegrated.com/en/storefront/storefront.html.

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#### ООО "ЛайфЭлектроникс"

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